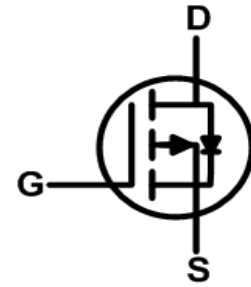
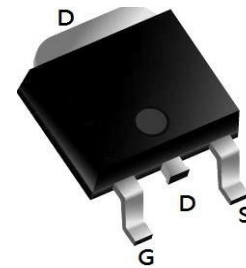




- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology



TO252 Pin Configuration



Description

The WLU40P02 is the high cell density trenched P-ch MOSFETs, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WLU40P02 meet the RoHS and Gree Product requirement 100% EAS guaranteed with full function reliability approved.

Product Summary

BVDSS	RDSON	ID
-20V	12mΩ	-40A

Absolute Maximum Ratings (TA = 25°C, unless otherwise noted)

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V _{DS}	-20	V
Gate-Source Voltage		V _{GS}	±12	V
Continuous Drain Current	T _A = 25°C	I _D	-40	A
	T _A = 100°C		-15.7	
Pulsed Drain Current ¹		I _{DM}	-66	A
Single Pulse Avalanche Energy ²		EAS	28.8	mJ
Total Power Dissipation	T _A = 25°C	P _D	30	W
Operating Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ³	R _{θJA}	41.6	°C/W



Electrical Characteristics (T_J = 25°C, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	V_{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-20	-	-	V	
Gate-body Leakage current	I_{GSS}	V _{DS} = 0V, V _{GS} = ±12V	-	-	±100	nA	
Zero Gate Voltage Drain Current	I_{DSS}	V _{DS} = -20V, V _{GS} = 0V	T _J = 25°C	-	-	-1	μA
			T _J = 100°C	-	-	-100	
Gate-Threshold Voltage	V_{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-0.4	-0.65	-1	V	
Drain-Source On-Resistance ⁴	R_{DS(on)}	V _{GS} = -4.5V, I _D = -8A	-	12.0	18	mΩ	
		V _{GS} = -2.5V, I _D = -6A	-	17	23		
Forward Transconductance ⁴	g_{fs}	V _{DS} = -4.5V, I _D = -8A	-	36	-	S	
Dynamic Characteristics⁵							
Input Capacitance	C_{iss}	V _{DS} = -10V, V _{GS} = 0V, f = 1MHz	-	1630	-	pF	
Output Capacitance	C_{oss}		-	211	-		
Reverse Transfer Capacitance	C_{rss}		-	187	-		
Gate Resistance	R_g	f = 1MHz	-	10	-	Ω	
Switching Characteristics⁵							
Total Gate Charge	Q_g	V _{GS} = -4.5V, V _{DS} = -10V, I _D = -8A	-	12	-	nC	
Gate-Source Charge	Q_{gs}		-	1.8	-		
Gate-Drain Charge	Q_{gd}		-	3.2	-		
Turn-On Delay Time	t_{d(on)}	V _{GS} = -4.5V, V _{DD} = -10V, R _G = 3Ω, I _D = -8A	-	17	-	ns	
Rise Time	t_r		-	25.5	-		
Turn-Off Delay Time	t_{d(off)}		-	32	-		
Fall Time	t_f		-	15	-		
Drain-Source Body Diode Characteristics							
Diode Forward Voltage ⁴	V_{SD}	I _S = -8A, V _{GS} = 0V	-	-	-1.2	V	
Continuous Source Current	I_S	T _A = 25°C	-	-	-40	A	

Notes:

1. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C.
2. The EAS data shows Max. rating . The test condition is V_{DD}= -25V, V_{GS}= -10V, L= 0.1mH, I_{AS}= -24A
3. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
4. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
5. This value is guaranteed by design hence it is not included in the production test..



Typical Characteristics

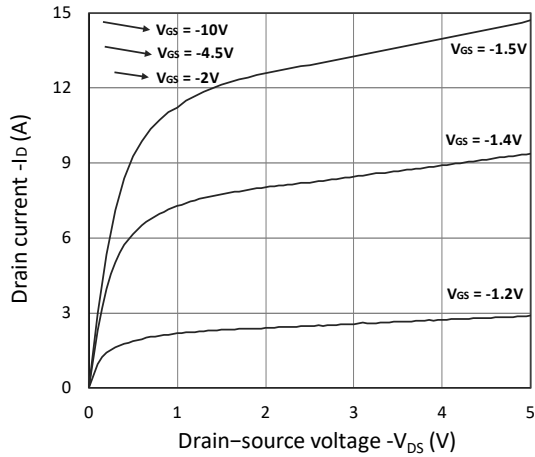


Figure 1. Output Characteristics

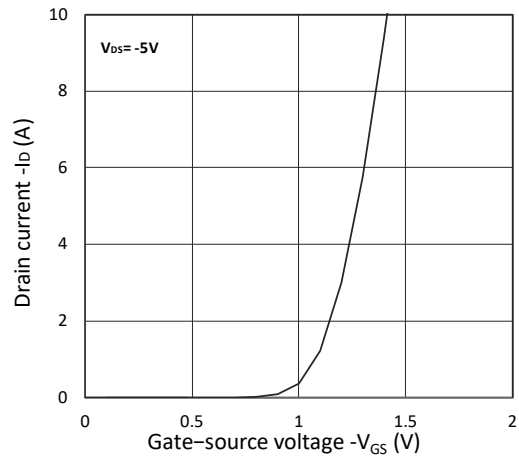


Figure 2. Transfer Characteristics

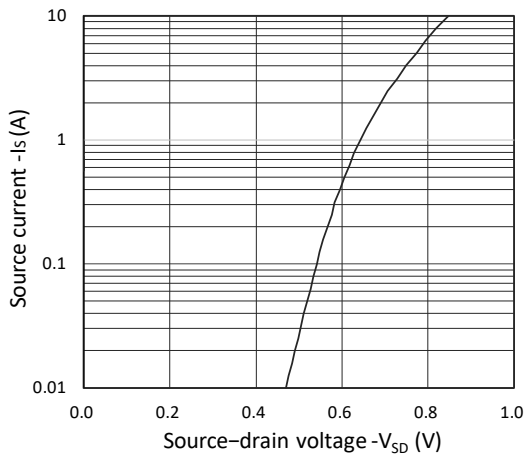


Figure 3. Forward Characteristics of Reverse

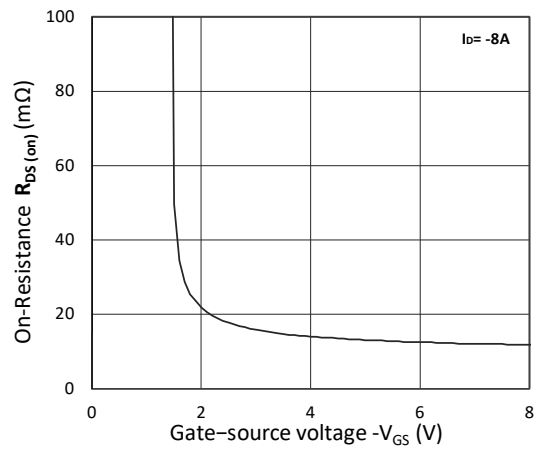


Figure 4. $R_{DS(ON)}$ vs. V_{GS}

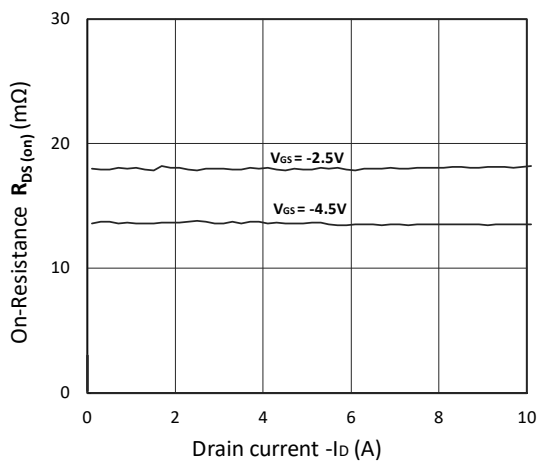


Figure 5. $R_{DS(ON)}$ vs. I_D

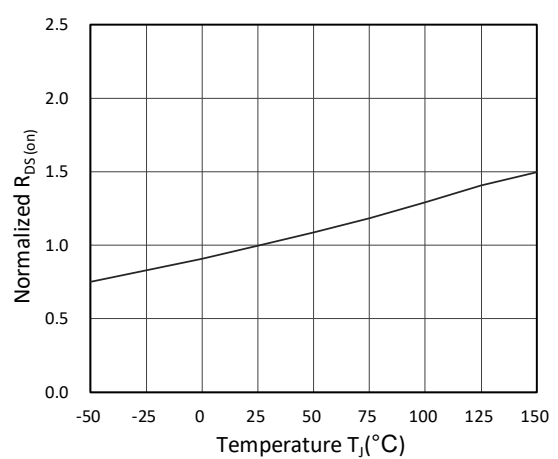


Figure 6. Normalized $R_{DS(on)}$ vs. Temperature

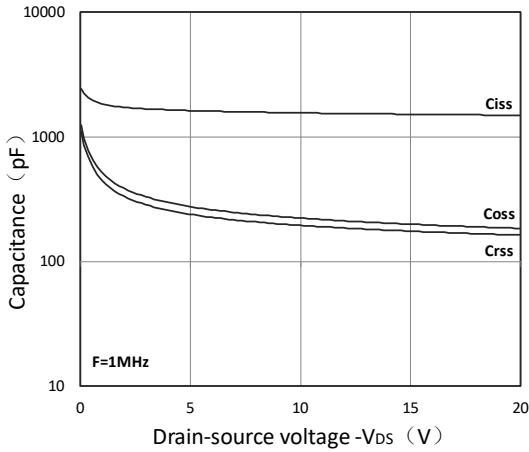


Figure 7. Capacitance Characteristics

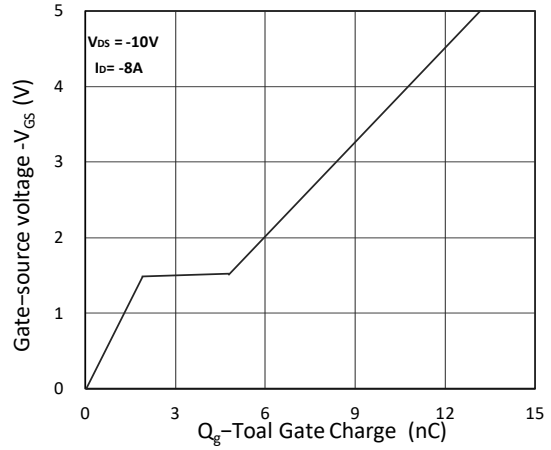


Figure 8. Gate Charge Characteristics

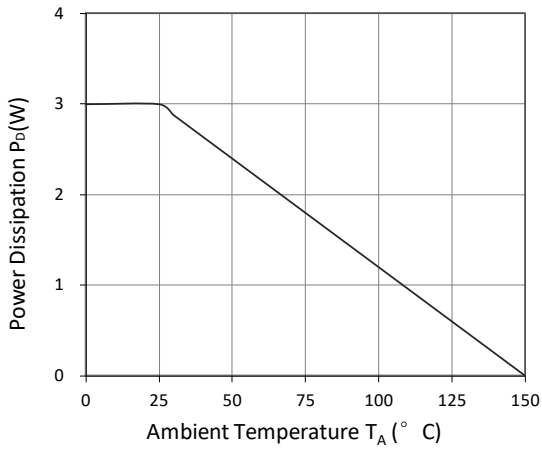


Figure 9. Power Dissipation

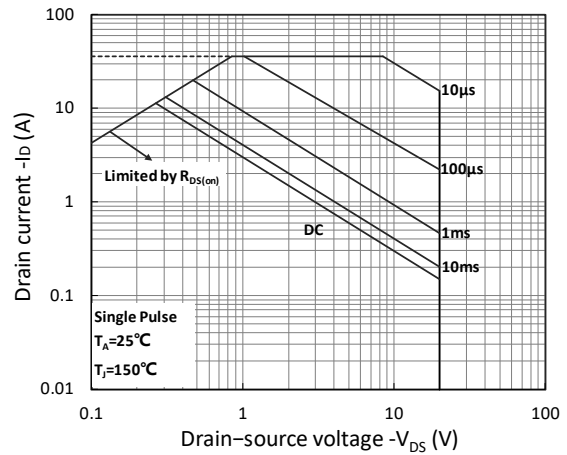


Figure 10. Safe Operating Area

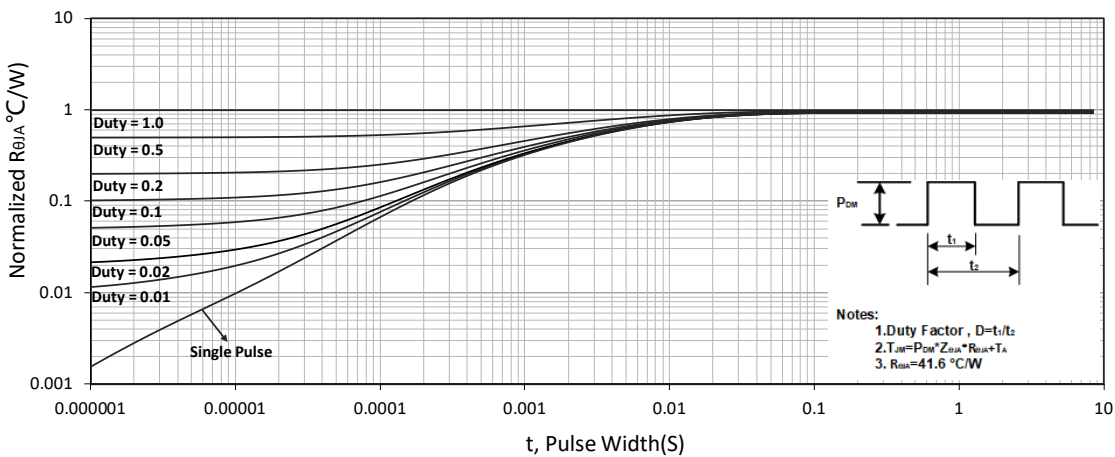
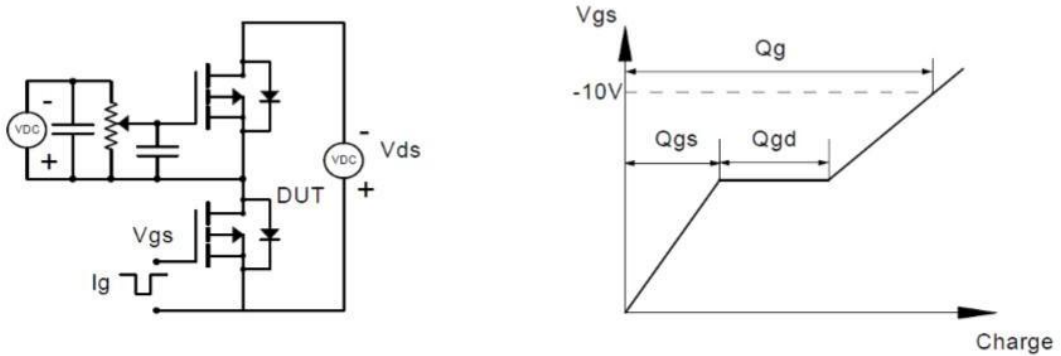


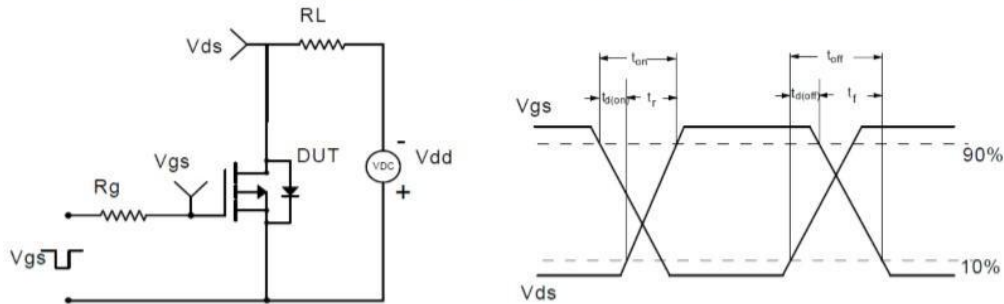
Figure 11. Normalized Maximum Transient Thermal Impedance

Test Circuit

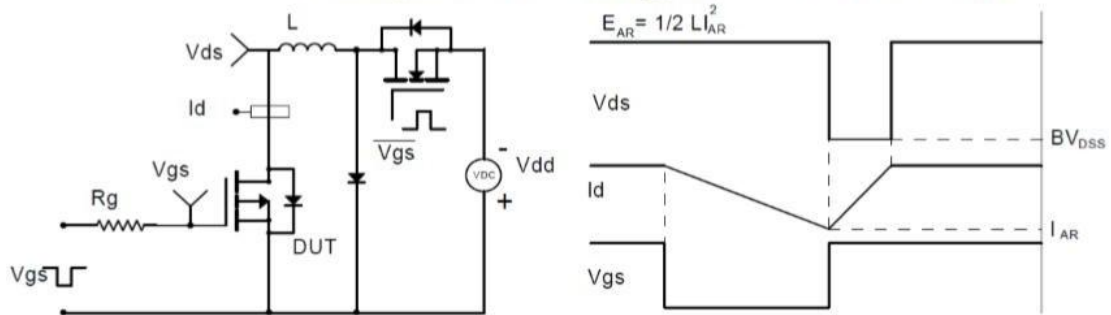
Gate Charge Test Circuit & Waveform



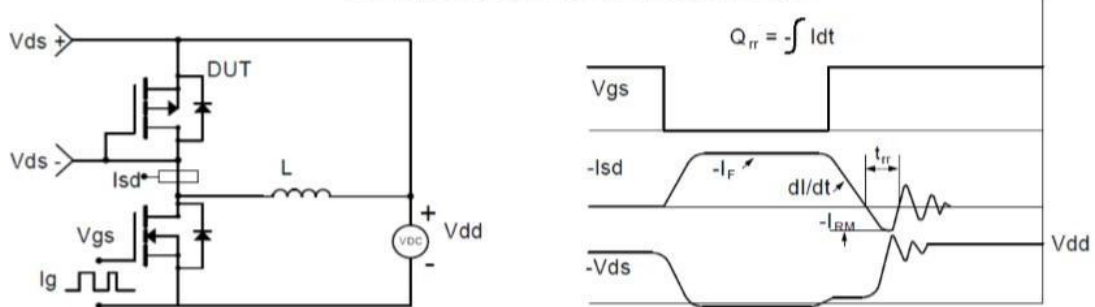
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

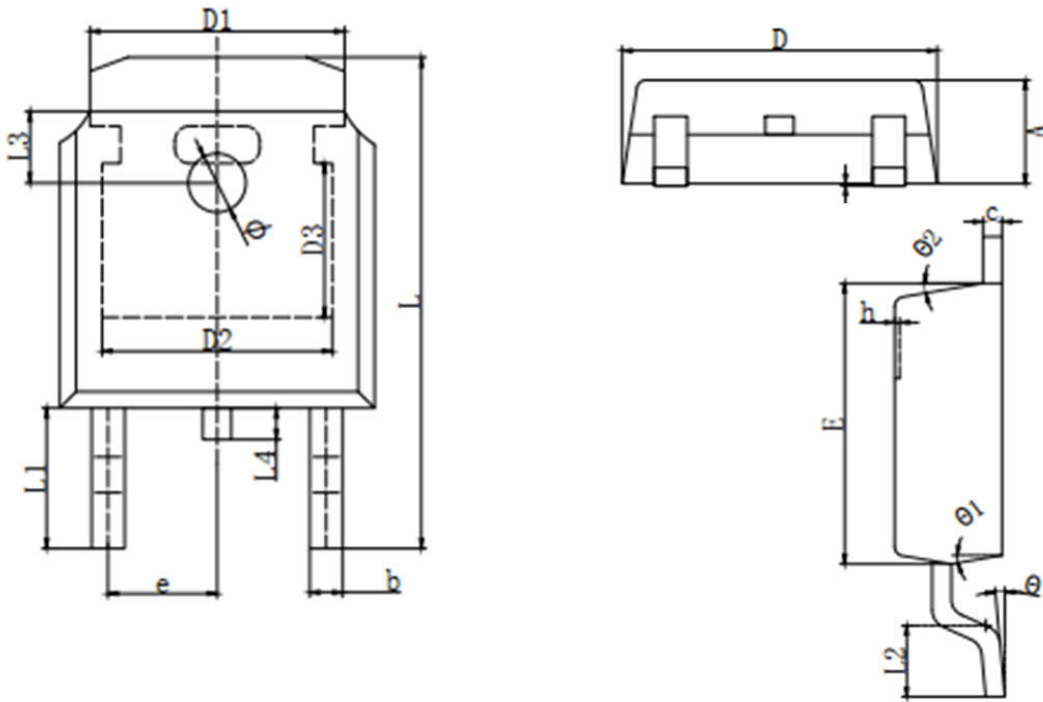


Diode Recovery Test Circuit & Waveforms





TO-252 Package outline



SYMBOL	MILLIMETER		SYMBOL	MILLIMETER	
	MIN	MAX		MIN	MAX
A	2.200	2.400	h	0.000	0.200
A1	0.000	0.127	L	9.900	10.30
b	0.640	0.740	L1	2.888 REF	
c	0.460	0.580	L2	1.400	1.700
D	6.500	6.700	L3	1.600 REF	
D1	5.334 REF		L4	0.600	1.000
D2	4.826 REF		ϕ	1.100	1.300
D3	3.166 REF		θ	0°	8°
E	6.000	6.200	$\theta 1$	9° TYP2	
e	2.286 TYP		$\theta 2$	9° TYP	



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